



## SURFACE MOUNT LOW LEAKAGE DIODE

**BAV116W** 

#### **Features**

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe; (Lead-Free Plating).
  - Solderable per MIL-STD-202, Method 208 🖲
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
BAV116W-7-F	SOD-123	3,000/Tape & Reel
BAV116W-13-F	SOD-123	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

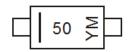
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

Notes:



50 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key													
Year	2000	2001	2002	2003		2015	2016	20	17 201	8 2019	2020	2021	2022
Code	L	М	Ν	Р		С	D	E	F	G	Н	I	J
Month	Jan	Feb	Mar	Apr	Ма	y Ji	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	(	6	7	8	9	0	Ν	D



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> Vrwm Vr	130	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	90	V
Forward Continuous Current		I <sub>FM</sub>	215	mA
Repetitive Peak Forward Current		I <sub>FRM</sub>	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	IFSM	4.0 1.0 0.5	A

## **Thermal Characteristics**

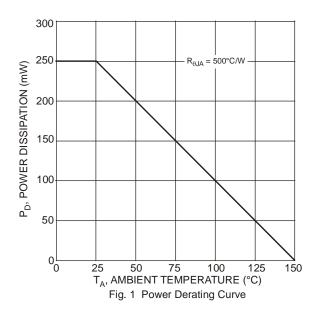
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>0</sub> JA	500	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-65 to +150	٥°

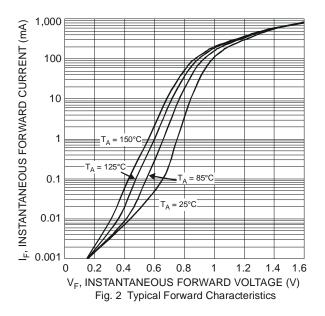
# **Electrical Characteristics** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	130 130		—	V	I <sub>R</sub> = 100μΑ I <sub>R</sub> = 100μΑ, Τ <sub>J</sub> =125°C
Forward Voltage	VF		_	0.90 1.0 1.1 1.25 1.0	V	$\begin{split} I_{F} &= 1.0 \text{mA}, \ T_{J} &= 25^{\circ}\text{C} \\ I_{F} &= 10 \text{mA}, \ T_{J} &= 25^{\circ}\text{C} \\ I_{F} &= 50 \text{mA}, \ T_{J} &= 25^{\circ}\text{C} \\ I_{F} &= 150 \text{mA}, \ T_{J} &= 25^{\circ}\text{C} \\ I_{F} &= 10 \text{mA}, \ T_{J} &= 125^{\circ}\text{C} \end{split}$
Leakage Current (Note 6)	I <sub>R</sub>		_	5.0 80	nA nA	$V_R = 75V, T_J = 25^{\circ}C$ $V_R = 75V, T_J = 125^{\circ}C$
Total Capacitance	Ст		2.4	5	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>		_	3.0	μs	$I_{F} = I_{R} = 10mA,$ $I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

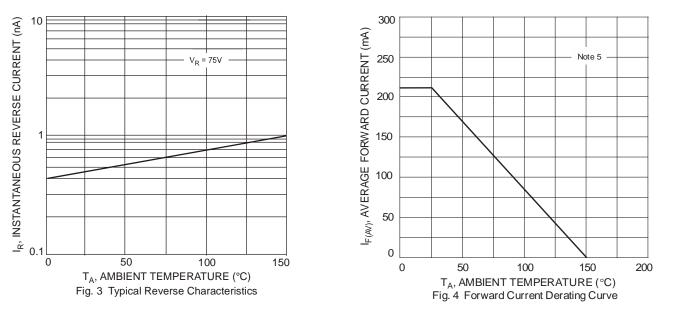
Notes:

Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
Short duration pulse test used to minimize self-heating effect .



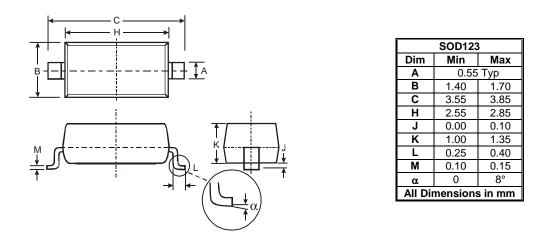






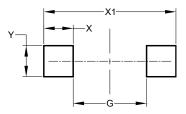
## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value(in mm)				
G	2.250				
Х	0.900				
X1	4.050				
Y	0.950				



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